LCD / LCM SPECIFICATION



WINSTAR Display Co.,Ltd. 華凌光電股份有限公司



WEB: https://www.winstar.com.tw E-mail: sales@winstar.com.tw

SPECIFICATION

MODULE NO.:	WG12232N-YY	H-VGB#
APPROVED BY: (FOR CUSTOMER USE ONLY)	PCB VERSION:	DATA:

SALES BY	APPROVED BY	CHECKED BY	PREPARED BY

VERSION	DATE	REVISED PAGE NO.	SUMMARY
Е	2021/07/13		Add Interface



MODLE NO:

華凌光電股份有限公司

RECORDS OF REVISION

DOC. FIRST ISSUE

VERSION	DATE	REVISED PAGE NO.		SUMMARY	
0	2011/01/10		Fi	rst issue	
Α	2015/12/23		Re	emove IC information	
			M	odify Electrical	
			Cł	naracteristics, Response	
			Ti	me & B/L information	
В	2016/01/27		M	odify Precautions in use	
			of	LCD Modules	
			8	Static electricity test	
C	2019/08/27		M	odify Material List of	
			Co	omponents for RoHs	
D	2019/12/17		Modify Precautions in use		
			of	LCD Modules	
Е	2021/07/13		A	dd Interface	

Contents

- 1.Module Classification Information
- 2. Precautions in use of LCD Modules
- 3.General Specification
- 4. Absolute Maximum Ratings
- 5. Electrical Characteristics
- 6. Optical Characteristics
- 7.Interface Pin Function
- 8. Contour Drawing & Block Diagram
- 9.Reliability
- 10.Backlight Information
- 11.Inspection specification
- 12. Material List of Components for RoHs
- 13.Recommendable Storage

1. Module Classification Information

① Brand: WINSTAR DISPLAY CORPORATION

② Display Type: H→Character Type, G→Graphic Type, X→TAB Type, O→COG Type

③ Display Font: 122 * 32 dot

Model serials no.

 \bigcirc Backlight Type: N \rightarrow Without backlight T \rightarrow LED, White L \rightarrow LED, Full color

 $B\rightarrow EL$, Blue green $A\rightarrow LED$, Amber $J\rightarrow DIP$ LED, Blue $D\rightarrow EL$, Green $R\rightarrow LED$, Red $K\rightarrow DIP$ LED, White

W→EL, White O→LED, Orange E→DIP LED, Yellow Green

 $M\rightarrow$ EL, Yellow Green $G\rightarrow$ LED, Green $H\rightarrow$ DIP LED, Amber $F\rightarrow$ CCFL, White $P\rightarrow$ LED, Blue $I\rightarrow$ DIP LED, Red

 $Y \rightarrow LED$, Yellow Green $X \rightarrow LED$, Dual color $G \rightarrow LED$, Green $C \rightarrow LED$, Full color

© LCD Mode : B→TN Positive, Gray V→FSTN Negative, Blue

N→TN Negative, T→FSTN Negative, Black

L→VA Negative D→FSTN Negative (Double film)

 $H \rightarrow HTN$ Positive, Gray $F \rightarrow FSTN$ Positive $I \rightarrow HTN$ Negative, Black $K \rightarrow FSC$ Negative $U \rightarrow HTN$ Negative, Blue $S \rightarrow FSC$ Positive

M→STN Negative, Blue E→ISTN Negative, Black
G→STN Positive, Gray C→CSTN Negative, Black
Y→STN Positive, Yellow Green A→ASTN Negative, Black

② LCD Polarize A→Reflective, N.T, 6:00 H→Transflective, W.T,6:00

Type/ Temperature D→Reflective, N.T, 12:00 K→Transflective, W.T,12:00 range/ View G→Reflective, W. T, 6:00 C→Transmissive, N.T,6:00

direction J→Reflective, W. T, 12:00 F→Transmissive, N.T,12:00

B→Transflective, N.T,6:00 I→Transmissive, W. T, 6:00

E→Transflective, N.T.12:00 L→Transmissive, W.T,12:00

Special Code
V : Build in positive voltage

GB:Simplified Character

#:Fit in with the ROHS Directions and regulations

2.Precautions in use of LCD Modules

- (1) Avoid applying excessive shocks to the module or making any alterations or modifications to it.
- (2)Don't make extra holes on the printed circuit board, modify its shape or change the components of LCD module.
- (3)Don't disassemble the LCM.
- (4)Don't operate it above the absolute maximum rating.
- (5)Don't drop, bend or twist LCM.
- (6) Soldering: only to the I/O terminals.
- (7)Storage: please storage in anti-static electricity container and clean environment.
- (8) Winstar have the right to change the passive components, including R3,R6 & backlight adjust resistors. (Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.)
- (9) Winstar have the right to change the PCB Rev. (In order to satisfy the supplying stability, management optimization and the best product performance...etc, under the premise of not affecting the electrical characteristics and external dimensions, Winstar have the right to modify the version.)
- (10) To ensure the stability of the display screen, please apply screen saver after showing 30 mins of fixed display content.
- (11)Please heat up a little the tape sticking on the components when removing it; otherwise the components might be damaged.

3.General Specification

Item	Dimension	Unit				
Number of Characters	122 x 32	_				
Module dimension	59.0 x 29.3 x 5.5(MAX)	mm				
View area	52.0 x 15.0	mm				
Active area	45.72x 11.97	mm				
Dot size	0.345 x 0.345	mm				
Dot pitch	0.375 x 0.375 mm					
LCD type	STN Positive, Yellow Green Transflective, (In LCD production, It will occur slightly color difference. We can only guarantee the same color in the same batch.)					
Duty	1/32					
View direction	6 o'clock					
Backlight Type	LED Yellow Green					
IC	ST7920					
Interface	68 series					

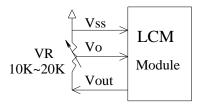
4.Absolute Maximum Ratings

Item	Symbol	Min	Тур	Max	Unit
Operating Temperature	Тор	-20	_	+70	${\mathbb C}$
Storage Temperature	T_{ST}	-30	_	+80	$^{\circ}$
Input Voltage	V _{IN}	-0.3	_	V _{DD} +0.3	V
Supply Voltage For Logic	$ m V_{DD} ext{-}V_{SS}$	-0.3	_	5.5	V
LCD Driver Voltage	$ m V_{LCD}$	-0.3	_	7.0	V

5.Electrical Characteristics

Item	Symbol	Condition	Min	Тур	Max	Unit
Supply Voltage For Logic	$ m V_{DD} ext{-}V_{SS}$	_	4.5	5.0	5.5	V
		Ta=-20°C	_	_	_	V
Supply Voltage For LCD *Note	$ m V_0 ext{-}V_{SS}$	Ta=25°C	4.2	4.35	4.5	V
		Ta=+70°C	_	_	_	V
Input High Volt.	$ m V_{IH}$	_	$0.7V_{DD}$	_	V_{DD}	V
Input Low Volt.	V_{IL}	_	-0.3	_	0.6	V
Output High Volt.	V_{OH}	_	$0.8~\mathrm{V_{DD}}$	_	V_{DD}	V
Output Low Volt.	V_{OL}	_	_	_	0.4	V
Supply Current	I_{DD}	V _{DD} =5.0V	0.8	1.0	1.5	mA

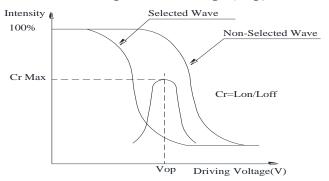
^{*}Note: Please design the VOP adjustment circuit on customer's main board



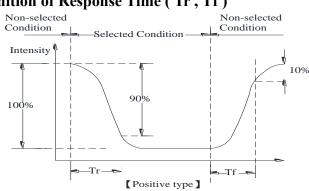
6.Optical Characteristics

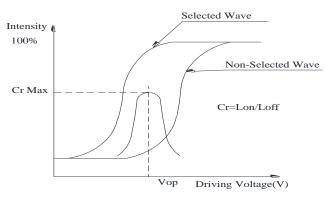
Item	Symbol	Condition	Min	Тур	Max	Unit
	θ	CR≧2	0	_	20	$\phi = 180^{\circ}$
V: A1 -	θ	CR≧2	0	_	40	$\phi = 0^{\circ}$
View Angle	θ	CR≧2	0	_	30	$\phi = 90^{\circ}$
	θ	CR≧2	0	_	30	$\phi = 270^{\circ}$
Contrast Ratio	CR	_	_	3	_	_
Response Time	T rise	_	_	150	200	ms
	T fall	_	_	150	200	ms

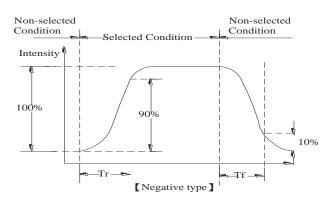
Definition of Operation Voltage (Vop)



Definition of Response Time (Tr, Tf)







Conditions:

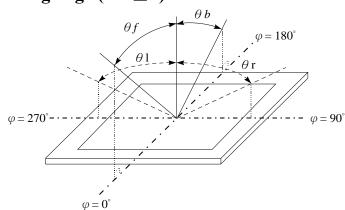
Operating Voltage: Vop

Frame Frequency: 64 HZ Driving W

Viewing Angle(θ , φ): 0° , 0°

Driving Waveform: 1/N duty, 1/a bias

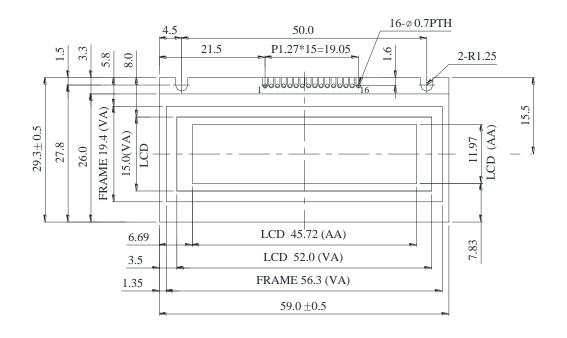
Definition of viewing angle $(CR \ge 2)$

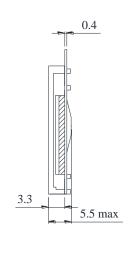


7.Interface Pin Function

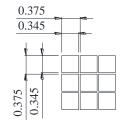
Pin No.	Symbol	Level	Description	
1	VLED	0V	B/L Selected	
2	V_{SS}	0V	Ground	
3	V_{DD}	5.0V	Power supply for logic	
4	Vo	(Variable)	Operating voltage for LCD	
5	RS	H/L	H: Data, L: Instruction	
6	Е	H/L	ENABLE SIGNAL	
7	VOUT		Positive Voltage Output	
8	DB0	H/L	Data bus line	
9	DB1	H/L	Data bus line	
10	DB2	H/L	Data bus line	
11	DB3	H/L	Data bus line	
12	DB4	H/L	Data bus line	
13	DB5	H/L	Data bus line	
14	DB6	H/L	Data bus line	
15	DB7	H/L	Data bus line	
16	R/W	H/L	H: Read; L: Write	

8.Contour Drawing & Block Diagram

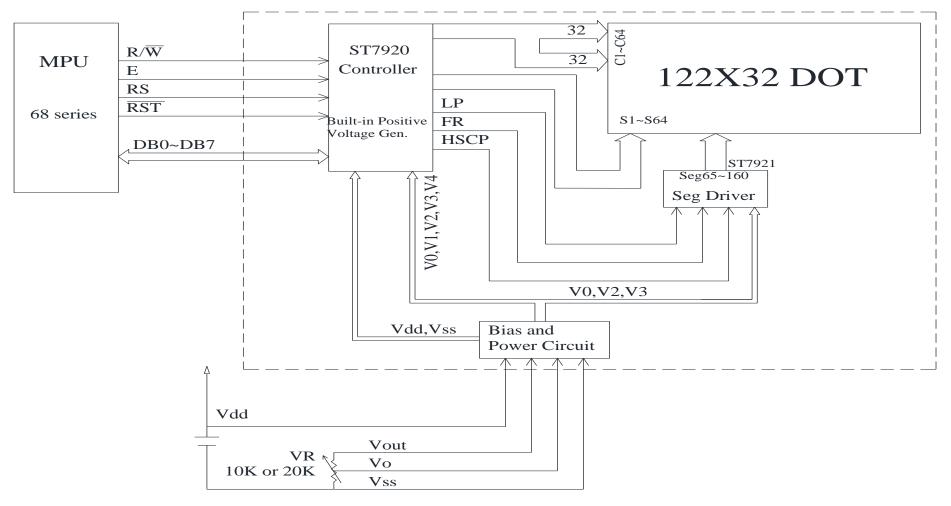




PIN NO.	SYMBOL
1	VLED
2	VSS
3	VDD
4	V0
5	RS
6	Е
7	VOUT
8	DB0
9	DB1
10	DB2
11	DB3
12	DB4
13	DB5
14	DB6
15	DB7
16	R/W



DOT SIZE SCALE 15/1 The non-specified tolerance of dimension is ± 0.3 mm .



External contrast adjustment.

9.Reliability

Content of Reliability Test (Wide temperature, -20°C~70°C)

Environmental Test					
Test Item	Content of Test	Test Condition	Not e		
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80°C 200hrs	2		
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-30°C 200hrs	1,2		
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70°C 200hrs	_		
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20°C 200hrs	1		
High Temperature/ Humidity storage	The module should be allowed to stand at 60 °C,90%RH max For 96hrs under no-load condition excluding the polarizer, Then taking it out and drying it at normal temperature.	60°C,90%RH 96hrs	1,2		
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation -20°C 25°C 70°C 30min 5min 30min 1 cycle	-20°C/70°C 10 cycles	_		
Vibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude: 1.5mm Vibration Frequency: 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	3		
Static electricity test	Endurance test applying the electric stress to the terminal.	$VS=\pm600V(contact),\\ \pm800v(air),\\ RS=330\Omega\\ CS=150pF\\ 10\ times$			

Note1: No dew condensation to be observed.

Note2: The function test shall be conducted after 4 hours storage at the normal

Temperature and humidity after remove from the test chamber.

Note3: The packing have to including into the vibration testing.

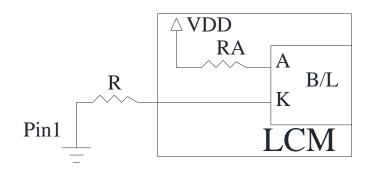
10.Backlight Information

Specification

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT	TEST CONDITION
Supply Current	ILED	32	40	60	mA	V=5.0V
Supply Voltage	V	4.9	5.0	5.1	V	_
Reverse Voltage	VR	_	_	8	V	_
Luminance (Without LCD)	IV	37.28	46.6	_	CD/M2	ILED=40mA
Life Time	_	_	50000	_	Hr.	V□5.0V
Color	Yellow Green					

Note: The LED of B/L is drive by current only, drive voltage is for reference only. drive voltage can make driving current under safety area (current between minimum and maximum).

Drive from Pin1,VDD



11.Inspection specification

No	Item			Criterion		AQL
01	Electrical Testing	Missing vertical, horizontal segment, segment contrast defect. Missing character, dot or icon. Display malfunction. No function or no display. Current consumption exceeds product specifications. LCD viewing angle defect. Mixed product types. Contrast defect.			0.65	
02	Black or white spots on LCD (display only)	three white or bl	2.1 White and black spots on display ≤0.25mm, no more than three white or black spots present. 2.2 Densely spaced: No more than two spots or lines within 3mm			2.5
03	LCD black spots, white spots, contamination (non-display)	3.1 Round type : As follow $\Phi = (x + y)/2$ $X \longrightarrow Y$ Y		SizeAcceptable QTY $\Phi \le 0.10$ Accept no dense $0.10 < \Phi \le 0.20$ 2 $0.20 < \Phi \le 0.25$ 1 $0.25 < \Phi$ 0ring drawing)OutputWidthAcceptable Q TY $W \le 0.02$ Accept no dense $0.02 < W \le 0.03$ 2		2.5
04	Polarizer bubbles	If bubbles are visible, judge using black spot specifications, not easy to find, must check in specify direction.		Size Φ $ Φ \le 0.20 $ $ 0.20 < Φ \le 0.50 $ $ 0.50 < Φ \le 1.00 $ $ 1.00 < Φ $ $ Total Q TY$	As round type Acceptable Q TY Accept no dense 3 2 0 3	2.5

No	Item	Criterion				
05	Scratches	Follow NO.3 LCD black spots, white spots, contamination				
	Chipped glass					
		z: Chip thickness	y: Chip width	x: Chip length		
		Z≦1/2t	Not over viewing area	$x \le 1/8a$		
06		$1/2t < z \leq 2t$	Not exceed 1/3k	x≤1/8a	2.5	
		6.1.2 Corner crack:	chips, x is total length o	of each chip.		
		z: Chip thickness	y: Chip width	x: Chip length		
		Z≤1/2t	Not over viewing area	x ≤ 1/8a		
		$1/2t < z \le 2t$	Not exceed 1/3k	$x \le 1/8a$		
		⊙ If there are 2 or more	chips, x is the total leng	gth of each chip.		

No	Item	Criterion					
No	Glass	remain and be inspected of the product will be damaged.	y: Chip width t: Glass thickness agth terminal: ode pad: x : Chip lengt $x \le 1/8a$ ve portion: $x \le 1/8a$ $x \le 1/8a$ a touches the ITO terminated according to elected according to elected above the liberance and internal of the state of the state of the liberance and internal of the state of the liberance and internal of the l	z: Chip thick a: LCD side Z th z: C x th z: C trode terminal, over 2/ trode terminal customer, the	Chip thickness $0 < z \le t$ Chip thickness $0 < z \le t$ Chip thickness $0 < z \le t$ 3 of the ITO must al specifications.	AQL 2.5	

No	Item	Criterion	AQL
07	Cracked glass	The LCD with extensive crack is not acceptable.	2.5
		8.1 Illumination source flickers when lit.	0.65
0.0	Backlight	8.2 Spots or scratched that appear when lit must be judged. Using	2.5
08	elements	LCD spot, lines and contamination standards.	
		8.3 Backlight doesn't light or color wrong.	0.65
		9.1 Bezel may not have rust, be deformed or have fingerprints,	2.5
09	Bezel	stains or other contamination.	
		9.2 Bezel must comply with job specifications.	0.65
		10.1 COB seal may not have pinholes larger than 0.2mm or	2.5
		contamination.	
		10.2 COB seal surface may not have pinholes through to the IC.	2.5
		10.3 The height of the COB should not exceed the height	0.65
		indicated in the assembly diagram.	
		10.4 There may not be more than 2mm of sealant outside the seal	2.5
		area on the PCB. And there should be no more than three places.	
		10.5 No oxidation or contamination PCB terminals.	
		10.6 Parts on PCB must be the same as on the production	2.5
10	PCB · COB	characteristic chart. There should be no wrong parts, missing parts or excess parts.	0.65
		10.7 The jumper on the PCB should conform to the product	
		characteristic chart.	0.65
		10.8 If solder gets on bezel tab pads, LED pad, zebra pad or	
		screw hold pad, make sure it is smoothed down.	2.5
		10.9 The Scraping testing standard for Copper Coating of PCB	
		V V	2.5
		\mathbf{Y} $\mathbf{X} * \mathbf{Y} \leq 2\mathbf{m}\mathbf{m}^2$	
		11.1 No un-melted solder paste may be present on the PCB.	2.5
		11.2 No cold solder joints, missing solder connections, oxidation	
11	Soldering	or icicle.	2.5
	6	11.3 No residue or solder balls on PCB.	2.5
		11.4 No short circuits in components on PCB.	0.65

NO	Item	Criterion	AQL
		12.1 No oxidation, contamination, curves or, bends on interface Pin	2.5
		(OLB) of TCP.	
		12.2 No cracks on interface pin (OLB) of TCP.	0.65
		12.3 No contamination, solder residue or solder balls on product.	2.5
		12.4 The IC on the TCP may not be damaged, circuits.	2.5
		12.5 The uppermost edge of the protective strip on the interface pin	2.5
	General appearance	must be present or look as if it cause the interface pin to sever.	
		12.6 The residual rosin or tin oil of soldering (component or chip	2.5
12		component) is not burned into brown or black color.	
		12.7 Sealant on top of the ITO circuit has not hardened.	2.5
		12.8 Pin type must match type in specification sheet.	0.65
		12.9 LCD pin loose or missing pins.	0.65
		12.10 Product packaging must the same as specified on packaging	0.65
		specification sheet.	
		12.11 Product dimension and structure must conform to product	0.65
		specification sheet.	
		12.12 Visual defect outside of VA is not considered to be rejection.	0.65

12.Material List of Components for

RoHs

1. WINSTAR Display Co., Ltd hereby declares that all of or part of products (with the mark "#"in code), including, but not limited to, the LCM, accessories or packages, manufactured and/or delivered to your company (including your subsidiaries and affiliated company) directly or indirectly by our company (including our subsidiaries or affiliated companies) do not intentionally contain any of the substances listed in all applicable EU directives and regulations, including the following substances.

Exhibit A: The Harmful Material List

Material	Cd	Pb	Hg	Cr6+	PBB	PBDE	DEHP	BBP	DBP	DIBP
Limited	100	1000	1000	1000	1000	1000	1000	1000	1000	1000
Value	ppm	ppm	ppm	ppm	ppm	ppm	ppm	ppm	ppm	ppm
Above limited value is set up according to RoHS.										

2. Process for RoHS requirement : (only for RoHS inspection)

(1) Use the Sn/Ag/Cu soldering surface; the surface of Pb-free solder is rougher than we used before.

(2) Heat-resistance temp. :

Reflow: 250°C,30 seconds Max.;

Connector soldering wave or hand soldering : 320°C, 10 seconds max.

(3) Temp. curve of reflow, max. Temp. : 235±5°C;

Recommended customer's soldering temp. of connector: 280°C, 3 seconds.

13. Recommendable Storage

- 1. Place the panel or module in the temperature 25°C±5°C and the humidity below 65% RH
- 2. Do not place the module near organics solvents or corrosive gases.
- 3. Do not crush, shake, or jolt the module.

lle Number:			Page: 1
Panel Specification:	D _{acc}		
Panel Type:	Pass	□ NG ,	
2. View Direction:	☐ Pass	□ NG ,	
Numbers of Dots:	☐ Pass	□ NG ,	
View Area:	☐ Pass	□ NG ,	
Active Area:	☐ Pass	□ NG ,	
6. Operating Temperature:	☐ Pass	□ NG ,	
7. Storage Temperature:	Pass	□ NG ,	
3. Others:			
Mechanical Specification:	□ p		
PCB Size:	☐ Pass	□ NG ,	
2. Frame Size:	☐ Pass	□ NG ,	
Materal of Frame:	☐ Pass	□ NG ,	
Connector Position:	Pass	□ NG ,	
5. Fix Hole Position:	Pass	□ NG ,	
Backlight Position:	Pass	□ NG ,	
7. Thickness of PCB:	Pass	□ NG ,	
B. Height of Frame to PCB:	Pass	□ NG ,	
). Height of Module:	☐ Pass	☐ NG ,	
0. Others:	Pass	☐ NG ,	
Relative Hole Size:			
. Pitch of Connector:	Pass	□ NG ,	
. Hole size of Connector:	Pass	□ NG ,	
Mounting Hole size:	Pass	□ NG ,	
. Mounting Hole Type:	Pass	□ NG ,	
Others:	Pass	☐ NG ,	
Backlight Specification :			
. B/L Type:	Pass	□ NG ,	
B/L Color:	Pass	☐ NG ,	
B/L Driving Voltage (Refere	nce for LED	Type): Pass	☐ NG ,
. B/L Driving Current:	Pass	☐ NG ,	
5. Brightness of B/L:	☐ Pass	□ NG ,	
5. B/L Solder Method:	☐ Pass	□ NG ,	
. Others:	Pass	☐ NG ,	



	winstar		
Modu	le Number :		Page: 2
5、	Electronic Characteristics of	Module:	
1.	Input Voltage:	Pass	\square NG ,
2.	Supply Current:	☐ Pass	□ NG ,
3.	Driving Voltage for LCD:	Pass	□ NG ,
4.	Contrast for LCD:	Pass	□ NG ,
5.	B/L Driving Method:	Pass	□ NG ,
6.	Negative Voltage Output:	Pass	□ NG ,
7.	Interface Function:	Pass	□ NG ,
8.	LCD Uniformity:	☐ Pass	□ NG ,
9.	ESD test:	☐ Pass	□ NG ,
10.	Others:	☐ Pass	□ NG ,
6、	Summary:		
	Sales signature:		-
	Customer Signature:		<u>Date: / /</u>